

## 16-Channel Low Knee Voltage PWM Constant Current LED Driver for Low Voltage Power Supply, 1:32 Time-Multiplexing Applications Features

- 3V-4.2V supply voltage
- Design optimization
- 16 constant current output channels
- Constant output current range:
  - 0.5~10mA @ 4.2V supply voltage
  - 0.5~5mA @ 3.3V supply voltage
- Low knee voltage of output channels
   V<sub>DS</sub>=0.3V @ I<sub>OUT</sub> = 10mA, V<sub>DD</sub>=4.2V
- Excellent output current accuracy:

Between channels:: <±2.5% (Max.)

Between ICs: <±3%(Max.)

- Built-in 16K-bit SRAM to support time-multiplexing for 1 ~ 32 scans
- 16-bit/14-bit /13-bit color depth PWM control to improve visual refresh rate
- 6bit current gain, 12.5%~200%
- LED failure isolation
  - -LED failure induced cross elimination
- LED open detection
- Integrating ghost elimination circuit
- GCLK multiplier technology
- Maximum DCLK frequency: 30MHz
- Package MSL Level : 3



# 16-Channel Low Knee Voltage PWM Constant Current LED Driver for Low Voltage Power Supply, 1:32 Time-multiplexing Applications

#### **Product Description**

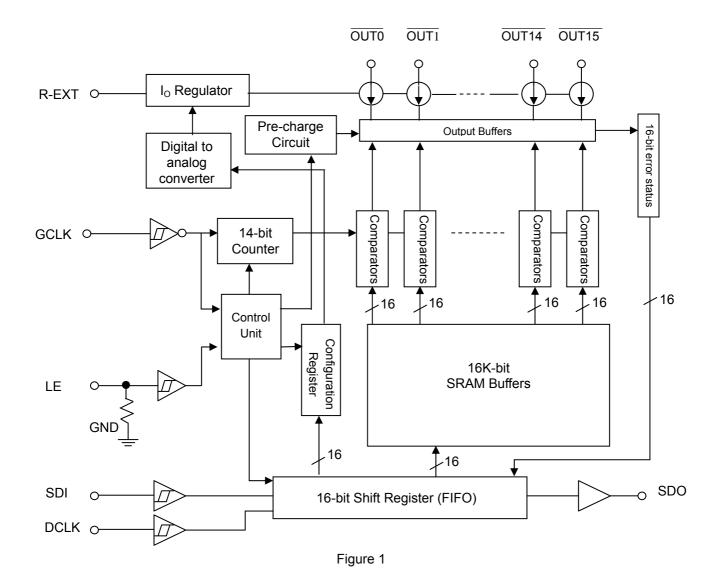
MBI5155 is designed for LED video applications using internal Pulse Width Modulation (PWM) control with selectable 16-bit / 14-bit / 13-bit color depth, and the circuit characteristics is optimized for applications with 4.2V supply voltage. MBI5155 features a 16-bit shift register which converts serial input data into each pixel's gray scale of the output port. Sixteen regulated current ports are designed to provide uniform and constant current sinks for driving LEDs with a wide range of V<sub>F</sub> variations. The output current can be preset through an external resistor. The innovative architecture with embedded SRAM is designed to support up to 1:16 time-multiplexing applications. Users only need to send the whole frame data once and to store in the embedded SRAM of the LED driver, instead of sending every time when the scan line is changed. It helps to save the data bandwidth and to achieve high grayscale with very low data clock rate. With scan-type Scrambled-PWM (S-PWM) technology, MBI5155 enhances PWM by scrambling the "on" time of each scan line into several "on" periods and sequentially drives each scan line for a short "on" period. The enhancement equivalently increases the visual refresh rate of scan-type LED displays. In addition, the innovative GCLK multiplier technique doubles visual refresh rate.

MBI5155 drives the corresponding LEDs to the brightness specified by image data. With MBI5155, all output channels can be built with 16-bit color depth (65,536 gray scales). When building a 16-bit color depth video, S-PWM technology reduces the flickers and improves the image fidelity.

Through compulsory error detection, MBI5155 detects individual LED for open-circuit errors without extra components. MBI5155 equipped an innovative cross elimination function, and it solves the cross phenomenon induced by failure LEDs. Besides, integrated ghost elimination circuit eases the ghosting problems. Embedded low grayscale processing technology effectively fixed the image display defects, and improved the quality of image display.

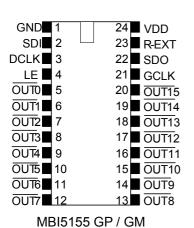
1:32 Time-multiplexing Applications

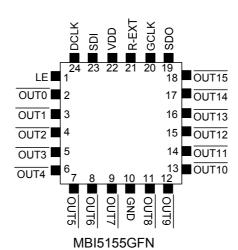
### **Block Diagram**



LED Driver for Low Voltage Power Supply, 1:32 Time-multiplexing Applications

### **Pin Configuration**





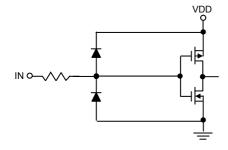
**Terminal Description** 

|              | <u> </u>  |
|--------------|---|
| Pin Name     | Function  |
| GND          | Ground terminal for control logic and current sink  |
| SDI          | Serial-data input to the shift register   |
| DCLK         | Clock input terminal used to shift data on rising edge and carries command information when LE is asserted.                           |
| LE           | Data strobe terminal and controlling command with DCLK  |
| OUT0 ~ OUT15 | Constant current output terminals   |
| GCLK         | Gray scale clock terminal Clock input for gray scale. The gray scale display is counted by gray scale clock compared with input data. |
| SDO          | Serial-data output to the receiver-end SDI of next LED driver   |
| R-EXT        | Input terminal used to connect an external resistor for setting up output current for all output channels                             |
| VDD          | 3.3V/5V supply voltage terminal   |

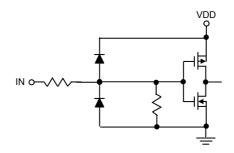
1:32 Time-multiplexing Applications

## **Equivalent Circuits of Inputs and Outputs**

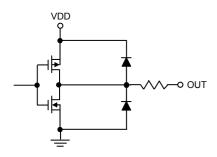
GCLK, DCLK, SDI terminal



**LE Terminal** 



#### **SDO Terminal**



## 16-Channel Low Knee Voltage PWM Constant Current LED Driver for Low Voltage Power Supply,

## 1:32 Time-multiplexing Applications

#### **Maximum Rating**

| Characte                               | ristic                       | Symbol           | Rating                    | Unit |
|--|------------------------------|------------------|---------------------------|------|
| Supply Voltage                         |                              | $V_{DD}$         | 0~7                       | V    |
| Input Pin Voltage (SDI, DCL            | K, GCLK, LE)                 | V <sub>IN</sub>  | -0.4~V <sub>DD</sub> +0.4 | V    |
| Sustaining Voltage at OUT P            | ort                          | V <sub>DS</sub>  | -0.5~17                   | V    |
| Output Current                         |                              | I <sub>OUT</sub> | +15                       | mA   |
| GND Terminal Current                   |                              | I <sub>GND</sub> | 250                       | mA   |
| Dower Dissipation                      | GP Type                      |                  | 1.79                      |      |
| Power Dissipation                      | GM Type                      | $P_{D}$          | 1.07                      | W    |
| (On 4 Layer PCB, Ta=25°C)*             | GFN Type                     |                  | 3.12                      |      |
| The arms of Decistors                  | GP Type                      |                  | 69.5                      |      |
| Thermal Resistance                     | GM Type                      | $R_{th(j-a)}$    | 93.5                      | °C/W |
| (On 4 Layer PCB, Ta=25°C) <sup>*</sup> | GFN Type                     |                  | 40.01                     |      |
| Junction Temperature                   |                              | $T_{j,max}$      | 150**                     | °C   |
| Operating Ambient Tempera              | ture                         | $T_{opr}$        | -40~+85                   | °C   |
| Storage Temperature                    |                              | $T_{stg}$        | -55~+150                  | °C   |
|  | IIL-STD-883H Method<br>015.8 | НВМ              | Class 3A<br>(5KV)         | -    |
|  | NSI/ESD S5.2-2009            | MM               | Class M3<br>(350V)        | -    |

<sup>\*</sup>The PCB size is 76.2mm\*114.3mm in simulation. Please refer to JEDEC JESD51.

Note: The performance of thermal dissipation is strongly related to the size of thermal pad, thickness and layer numbers of the PCB. The empirical thermal resistance may be different from simulative value. User should plan for expected thermal dissipation performance by selecting package and arranging layout of the PCB to maximize the capability.

<sup>\*\*</sup> Operation at the maximum rating for extended periods may reduce the device reliability; therefore, the suggested junction temperature of the device is under 125°C.

## Electrical Characteristics (V<sub>DD</sub>=4.2V, Ta=25°C)

| C                 | haracteris   | tics   | Symbol                            |  | Condi  | tion                     | Min.                 | Тур.         | Max. | Unit  |
|-------------------|--|--|-----------------------------------|--|--|--------------------------|----------------------|--------------|------|-------|
| Supply Vo         | oltage   |  | $V_{DD}$                          | -  |  |                          | 3.8                  | 4.2          | 4.6  | V     |
| Sustainin         | g Voltage at   | OUT Ports  | $V_{DS}$                          | OUT0∼ OU   | T15  |                          | -                    | -            | 17.0 | V     |
|                   |  |  |                                   |  | Refer to "Test Circuit for Electrical Characteristics" |                          | 0.5                  | -            | 10.0 | mA    |
| Output Cι         | urrent   |  | I <sub>OH</sub>                   | SDO  |  | -                        | -                    | -1.0         | mA   |       |
|                   |  |  | I <sub>OL</sub>                   | SDO  |  | -                        | -                    | 1.0          | mA   |       |
| l.a.a4 \ /a.l4    |  | "H" level  | level V <sub>IH</sub> Ta=-40~85°C |  | $0.7xV_{DD}$   | -                        | $V_{DD}$             | V            |      |       |
| Input Volt        | age  | "L" level  | V <sub>IL</sub>                   | Ta=-40~85°C  |  | GND                      | -                    | $0.3xV_{DD}$ | V    |       |
| Output Le         | akage Curr   | ent  | I <sub>OH</sub>                   | V <sub>DS</sub> =17.0V                               |  |                          | -                    | -            | 0.5  | μA    |
| Ott ) / s         | lta s. s   | 000  | V <sub>OH</sub>                   | I <sub>OH</sub> =-1.0mA                              |  |                          | V <sub>DD</sub> -0.4 | -            | -    | V     |
| Output vo         | put Voltage $V_{OL}$ $I_{OL}$ $I_{OL}$ $I_{OL}$ $I_{OL}$ |  |                                   | -  | -  | 0.4                      | V                    |              |      |       |
| Current S         | kew (Chanr   | nel)   | dl <sub>OUT1</sub>                | I <sub>OUT</sub> =0.5mA<br>V <sub>DS</sub> =1.0V     |  | R <sub>ext</sub> =28.8kΩ | -                    | ±1.5         | ±2.5 | %     |
| Current S         | kew (IC)   |  | dl <sub>OUT2</sub>                | $I_{OUT}$ =0.5mA<br>$V_{DS}$ =1.0V                   |  | R <sub>ext</sub> =28.8kΩ | -                    | ±1.5         | ±3.0 | %     |
| Output Cu         | urrent vs.<br>oltage Regu                                | lation*  | %/dV <sub>DS</sub>                | $V_{DS}$ within 1. $R_{ext}$ =3K $\Omega$ @5         |  | d 3.0V,                  | -                    | ±0.1         | ±0.3 | % / V |
| Output Cu         |  |  | %/dV <sub>DD</sub>                | V <sub>DD</sub> within 3.<br>R <sub>ext</sub> =3KΩ@5 | 8V and   | d 4.6V                   | -                    | ±1.0         | ±2.0 | % / V |
| LED Oper          | n Detection  | Threshold  | $V_{\text{OD,TH}}$                | -  |  |                          | -                    | 0.5          | -    | ٧     |
| Pull-down         | Resistor   |  | R <sub>IN</sub> (down)            | LE   |  |                          | 250                  | 450          | 800  | ΚΩ    |
|                   | "(   | Off"   | I <sub>DD</sub> (off) 1           | R <sub>ext</sub> =Open,                              | OUT  | 0~ OUT15=Off             | -                    | 3.2          | 4.2  |       |
|                   | (SDI=DC  | K=GCLK I <sub>DD</sub> (off) 2 R <sub>m=28 8KO</sub> OUT0~OUT15=Of |                                   |  | -  | 3.5                      | 4.5                  |              |      |       |
| Supply<br>Current | =0   | Hz)  | I <sub>DD</sub> (off) 3           | $R_{ext}$ =3K $\Omega$ ,                             | OUT  | 0~ OUT15=Off             | -                    | 5.0          | 6.0  | mA    |
|                   | _  | )n"<br>LK=5MHz,  | I <sub>DD</sub> (on) 2            | R <sub>ext</sub> =28.8KΩ                             | OUT  | 0~ OUT15=On              | -                    | 4.0          | 5.0  |       |
|                   |  | 20MHz)   | I <sub>DD</sub> (on) 3            | $R_{ext}$ =3K $\Omega$ ,                             | OUT  | 0~ OUT15=On              | -                    | 5.5          | 6.5  |       |

<sup>\*</sup>One channel on.

## 1:32 Time-multiplexing Applications

## Electrical Characteristics (V<sub>DD</sub>=3.3V, Ta=25°C)

| Ch                        | naracteri                               | stics                 | Symbol                  | <u>(- DD - 3 - 5</u>                             | Cond   | dition                    | Min. | Тур.     | Max.         | Uni<br>t |
|---------------------------|---|-----------------------|-------------------------|--|--------|---------------------------|------|----------|--------------|----------|
| Supply Volt               | tage                                    |                       | $V_{DD}$                |  |        | -                         | 3.0  | 3.3      | 3.6          | ٧        |
| Sustaining                | Voltage a                               | at OUT Ports          | $V_{DS}$                | OUT0∼ OUT  | 15     |                           | -    | -        | 17.0         | ٧        |
|                           |   |                       | I <sub>OUT</sub>        | Refer to "Test<br>Characteristic                 |        | it for Electrical         | 0.5  | -        | 5            | mA       |
| Output Cur                | rent                                    |                       | I <sub>OH</sub>         | SDO  | DO     |                           |      |          | -1.0         | mA       |
|                           |   |                       | I <sub>OL</sub>         | SDO  |        | -                         | -    | 1.0      | mA           |          |
| Input Voltag              | ge                                      | "H" level             | V <sub>IH</sub>         | Ta=-40~85°C                                      |        | 0.7xV <sub>D</sub>        | -    | $V_{DD}$ | V            |          |
|                           | 90                                      | "L" level             | $V_{IL}$                | Ta=-40~85°C                                      |        |                           | GND  | -        | $0.3xV_{DD}$ | ٧        |
| Output Lea                | kage Cur                                | rent                  | I <sub>OH</sub>         | V <sub>DS</sub> =17.0V                           |        |                           | -    | -        | 0.5          | μΑ       |
| Ott \ / =  t              | utput Voltage SDO                       |                       |                         | I <sub>OH</sub> =-1.0mA                          |        | V <sub>DD</sub> -0.4      | -    | -        | ٧            |          |
| Output voit               | utput Voltage SDO                       |                       | V <sub>OL</sub>         | I <sub>OL</sub> =+1.0mA                          |        | -                         | -    | 0.4      | ٧            |          |
| Current Ske               | utput Voltage SDO urrent Skew (Channel) |                       | dl <sub>OUT1</sub>      | I <sub>OUT</sub> =0.5mA<br>V <sub>DS</sub> =1.0V |        | R <sub>ext</sub> =28.8kΩ  | -    | ±1.5     | ±2.5         | %        |
| Current Ske               | ew (IC)                                 |                       | dl <sub>OUT2</sub>      | $I_{OUT}$ =0.5mA<br>$V_{DS}$ =1.0V               |        | $R_{ext}$ =28.8k $\Omega$ | -    | ±1.5     | ±3.0         | %        |
| Output Cur<br>Output Volt |   | ulation*              | %/dV <sub>DS</sub>      | $V_{DS}$ within 1.0 $R_{ext}$ =3K $\Omega$ @5r   | 13.0V, | -                         | ±0.1 | ±0.3     | % /<br>V     |          |
| Output Cur<br>Supply Volt |   | ulation*              | %/dV <sub>DD</sub>      | $V_{DD}$ within 3.0 $R_{ext}$ =3K $\Omega$ @5r   |        | I 3.6V                    | -    | ±1.0     | ±2.0         | % /<br>V |
| LED Open                  | Detection                               | Threshold             | $V_{OD,TH}$             | -  |        |                           | -    | 0.5      | -            | <b>V</b> |
| Pull-down F               | Resistor                                |                       | R <sub>IN</sub> (down)  | LE   |        |                           | 250  | 450      | 800          | ΚΩ       |
|                           |   | "Off"                 | I <sub>DD</sub> (off) 1 | R <sub>ext</sub> =Open,                          | OUT    | )~ OUT15=Off              | -    | 3.0      | 4.0          |          |
|                           | (SDI=D                                  | CLK=GCLK              | I <sub>DD</sub> (off) 2 | R <sub>ext</sub> =28.8KΩ,                        | OUTO   | )~ OUT15=Off              | -    | 3.3      | 4.3          |          |
| Supply<br>Current         | =                                       | =0Hz)                 | I <sub>DD</sub> (off) 3 |  |        | o~ OUT15=Off              | -    | 4.8      | 5.8          | mA       |
|                           |   | "On"<br>CLK=5MHz,     | I <sub>DD</sub> (on) 2  | R <sub>ext</sub> =28.8KΩ,                        | OUTO   | )~ OUT15=On               | -    | 3.8      | 4.8          |          |
|                           |   | CEK=5MHZ,<br>K=20MHz) | I <sub>DD</sub> (on) 3  | $R_{ext}$ =3K $\Omega$ ,                         | OUT    | )~ OUT15=On               | -    | 5.3      | 6.3          |          |

<sup>\*</sup>One channel on.

#### **Test Circuit for Electrical Characteristics**

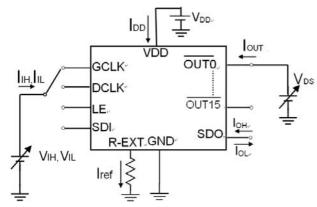


Figure 2

## 1:32 Time-multiplexing Applications

**Switching Characteristics (V<sub>DD</sub>=4.2V, Ta=25°C)** 

| Characteristics                      |                     | Symbol                   | Condition  | Min. | Тур. | Max. | Unit |
|--------------------------------------|---------------------|--------------------------|--|------|------|------|------|
|                                      | SDI - DCLK↑         | t <sub>SU0</sub>         |  | 5    | -    | -    | ns   |
| Catura Tira                          | LE↑ – DCLK↑         | t <sub>SU1</sub>         |  | 8    | -    | -    | ns   |
| Setup Time                           | LE ↓ (Vsync) – GCLK | t <sub>SU2</sub>         |  | 1200 |      |      | ns   |
|                                      | LE ↓ - DCLK↑        | t <sub>SU3</sub>         |  | 50   |      |      | ns   |
|                                      | DCLK↑ - SDI         | t <sub>H0</sub>          |  | 6    | -    | -    | ns   |
| Hold Time                            | DCLK↑ - LE          | t <sub>H1</sub>          |  | 8    | -    | -    | ns   |
|                                      | GCLK – LE ↑ (Vsync) | t <sub>H2</sub>          |  | 300  |      |      | ns   |
|                                      | DCLK - SDO          | t <sub>PD0</sub>         | V <sub>DD</sub> =4.2V                                    | -    | 22   | 25   | ns   |
| Propagation Delay<br>Time            | GCLK – OUT2n*       | t <sub>PD1</sub>         | V <sub>IH</sub> =V <sub>DD</sub><br>V <sub>IL</sub> =GND | -    | 35   | -    | ns   |
|                                      | LE – SDO            | t <sub>PD2</sub> ***     | $R_{ext}$ =1.4 $K\Omega$<br>$V_{DS}$ =1 $V$              | -    | 30   | 40   | ns   |
| Pulse Width                          | LE                  | $t_{w(LE)}$              | $R_L$ =300 $\Omega$                                      | 15   |      |      | ns   |
| Command to Commar                    | nd                  | Tcc                      | $C_L$ =10pF<br>$C_1$ =100nF                              | 50   | -    | _    | ns   |
| Data Clock Frequency                 | ,                   | F <sub>DCLK</sub>        | $C_2 = 10 \mu F$   | -    | -    | 30   | MHz  |
| Gray Scale Clock Fred                | quency***           | F <sub>GCLK</sub>        | $C_{SDO}$ =10pF<br>$V_{LED}$ =4.0V                       | -    | -    | 33   | MHz  |
| GCLK frequency ( when GCLK multiplie | r is enabled )      | F <sub>GCLK</sub>        |  |      |      | 16.6 | MHz  |
| Min Clock(GCLK/DCL                   | K) Pulse Width****  | t <sub>W(CLK)</sub>      |  | 12   | -    | _    | ns   |
| Ratio of (GCLK freq)/(               | DCLK freq)          | R <sub>(GCLK/DCLK)</sub> |  | 20   | -    | -    | %    |
| Compulsory Error Dete                | ection Operation    | t <sub>ERR-C</sub>       |  | 700  | -    | -    | ns   |
| Output Rise Time of O                | utput Ports         | t <sub>OR</sub>          |  | -    | 15   | 25   | ns   |
| Output Fall Time of Ou               | ıtput Ports         | t <sub>OF</sub>          |  | -    | 15   | 25   | ns   |
| Dead Time                            |                     | t <sub>dth</sub>         |  | 300  |      |      | ns   |
| Dead Time ( Low state                | e)                  | t <sub>dtl</sub>         |  | 1200 | -    | -    | ns   |

<sup>\*</sup>Output waveforms have good uniformity among channels.

<sup>\*\*</sup> Refer to the Timing Waveform, where n=0, 1, 2, 3, 4, 5, 6, 7.

<sup>\*\*\*</sup>In timing of "configuration read", the next DCLK rising edge should be t<sub>PD2</sub> after LE's falling edge.

<sup>\*\*\*\*</sup>The Gray Scale Clock period must be 50% duty cycle when the function of GCLK multiplier is enabled.

<sup>\*\*\*\*\*\*</sup>Users have to leave more time than the maximum error detection time for the error detection.

## 16-Channel Low Knee Voltage PWM Constant Current

## LED Driver for Low Voltage Power Supply,

## 1:32 Time-multiplexing Applications

**Switching Characteristics (V<sub>DD</sub>=3.3V, Ta=25°C)** 

| Characteristics                       |                     | Symbol                   | Condition  | Min. | Тур. | Max. | Unit |
|---------------------------------------|---------------------|--------------------------|--|------|------|------|------|
|                                       | SDI - DCLK ↑        | t <sub>suo</sub>         |  | 7    | -    | -    | ns   |
| Catura Tima                           | LE – DCLK ↑         | t <sub>SU1</sub>         |  | 10   | -    | -    | ns   |
| Setup Time                            | LE ↓ (Vsync) – GCLK | t <sub>SU2</sub>         |  | 1200 | -    | -    | ns   |
|                                       | LE↓ – DCLK↑         | t <sub>su3</sub>         |  | 52   |      |      | ns   |
|                                       | DCLK↑ - SDI         | t <sub>HO</sub>          |  | 8    | -    | -    | ns   |
| Hold Time                             | DCLK↑ - LE          | t <sub>H1</sub>          |  | 10   | -    | -    | ns   |
|                                       | GCLK – LE ↓ (Vsync) | t <sub>H2</sub>          |  | 300  | -    | -    | ns   |
|                                       | DCLK - SDO          | t <sub>PD0</sub>         | $V_{DD}$ =3.3 $V$  | -    | 25   | 30   | ns   |
| Propagation Delay<br>Time             | GCLK –OUT2n*        | t <sub>PD1</sub>         | V <sub>IH</sub> =V <sub>DD</sub><br>V <sub>IL</sub> =GND | -    | 45   | -    | ns   |
| Time                                  | LE – SDO            | t <sub>PD2</sub> ***     | $R_{ext}$ =1.4K $\Omega$                                 |      | 40   | 50   | ns   |
| Pulse Width                           | LE **               | $t_{w(LE)}$              | $V_{DS}$ =1 $V$<br>$R_L$ =300 $\Omega$                   | 16   |      |      | ns   |
| Command to Comman                     | d                   | tcc                      | $C_L$ =10pF<br>$C_1$ =100nF                              | 52   | -    | -    | ns   |
| Data Clock Frequency                  |                     | F <sub>DCLK</sub>        | $C_2 = 10 \mu F$   | -    | -    | 25   | MHz  |
| Gray Scale Clock Freq                 | uency****           | F <sub>GCLK</sub>        | $C_{SDO}$ =10pF<br>$V_{LED}$ =4.0V                       | _    | -    | 20   | MHz  |
| GCLK frequency ( when GCLK multiplier | r is enabled )      | F <sub>GCLK</sub>        |  |      |      | 10   | MHz  |
| Min Clock(GCLK/DCLk                   | () Pulse Width****  | t <sub>W(CLK)</sub>      |  | 13   |      |      | ns   |
| Ratio of (GCLK freq)/(E               | OCLK freq)          | R <sub>(GCLK/DCLK)</sub> |  | 20   |      | -    | %    |
| Compulsory Error Dete time*****       | ection Operation    | t <sub>ERR-C</sub>       |  | 700  | -    | -    | ns   |
| Output Rise Time of Output            | utput Ports         | t <sub>OR</sub>          |  |      | 25   | 35   | ns   |
| Output Fall Time of Ou                | tput Ports          | t <sub>OF</sub>          |  |      | 25   | 35   | ns   |
| Dead Time                             |                     | tdth                     |  | 300  | -    | -    | ns   |
| Dead Time ( Low state                 | )                   | tdtl                     |  | 1200 | -    | -    | ns   |

<sup>\*</sup>Output waveforms have good uniformity among channels.

<sup>\*\*</sup> Refer to the Timing Waveform, where n=0, 1, 2, 3, 4, 5, 6, 7.

<sup>\*\*\*</sup>In timing of "configuration read", the next DCLK rising edge should be t<sub>PD2</sub> after LE's falling edge.

<sup>\*\*\*\*</sup>The Gray Scale Clock period must be 50% duty cycle when the function of GCLK multiplier is enabled.

<sup>\*\*\*\*\*\*</sup>Users have to leave more time than the maximum error detection time for the error detection.

## **Test Circuit for Switching Characteristics**

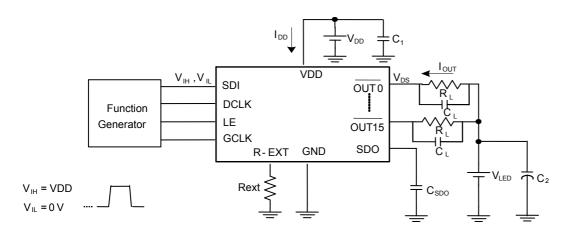
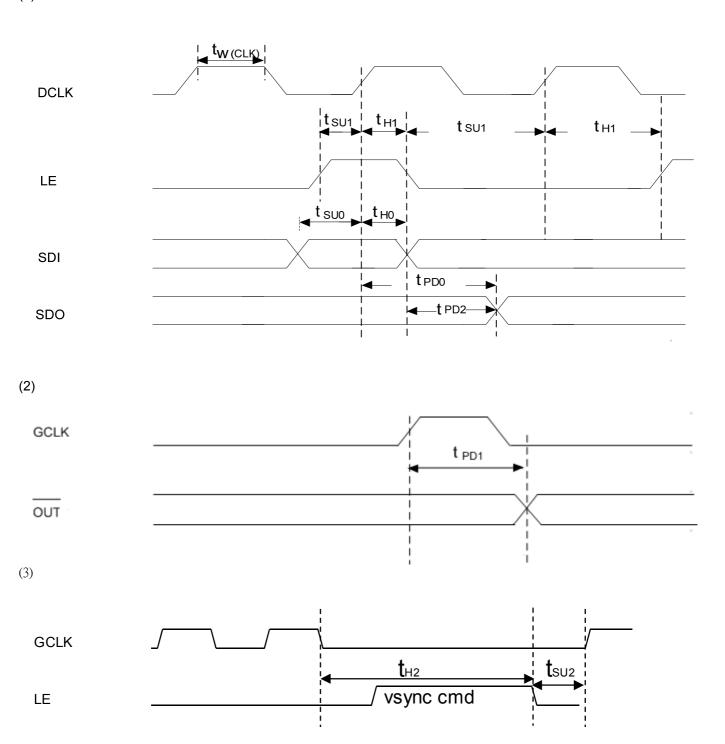


Figure 3

## **Timing Waveform**

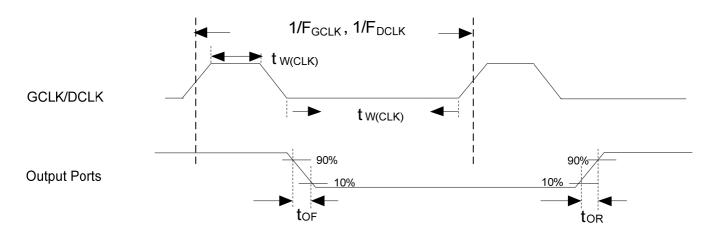
(1)



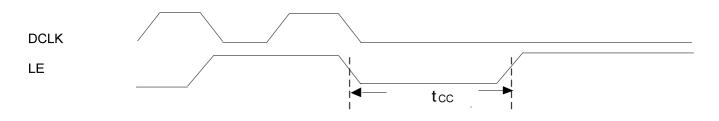
## 16-Channel Low Knee Voltage PWM Constant Current LED Driver for Low Voltage Power Supply,

1:32 Time-multiplexing Applications

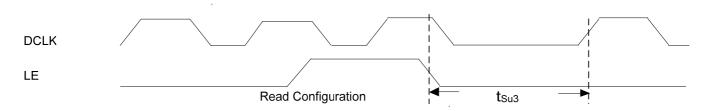
(4)



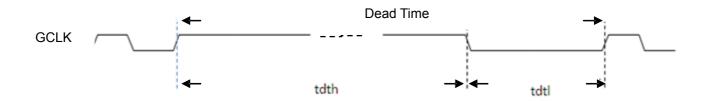
(5)



(6)



(7)



#### **Control Command**

|                                  | Signa | als Combination                                | Description   |  |  |  |  |  |
|----------------------------------|-------|--|---|--|--|--|--|--|
| Command Name                     | LE    | Number of DCLK Rising Edge when LE is asserted | Action of Command   |  |  |  |  |  |
| Stop Compulsory Error detection  | High  | 1  | Stop compulsory LED open detection.   |  |  |  |  |  |
| Data Latch                       | High  | 1  | Serial data are transferred to the input data buffers.                          |  |  |  |  |  |
| VSYNC                            | High  | 2  | Vertical Synchronal signal. Displaying frame will be updated to output channel. |  |  |  |  |  |
| Write Configuration 1*           | High  | 4  | Serial data are written to the configuration register.1                         |  |  |  |  |  |
| Read Configuration 1             | High  | 5  | Serial data are read from the configuration register.1                          |  |  |  |  |  |
| Start Compulsory Error detection | High  | 7  | Start compulsory LED open detection   |  |  |  |  |  |
| Write Configuration 2*           | High  | 8  | Serial data are written to the configuration register.2                         |  |  |  |  |  |
| Read Configuration 2             | High  | 9  | Serial data are read from the configuration register.2                          |  |  |  |  |  |
| Software Reset                   | High  | 10   | Reset the behavior of MBI5155 except the value of configuration registers.      |  |  |  |  |  |
| Pre-Active                       | High  | 14   | Pre-Active command needs to be sent before "Write Configuration" command.       |  |  |  |  |  |

<sup>\*</sup>Those commands can only be activated after Pre-Active command; otherwise, they will be invalid.

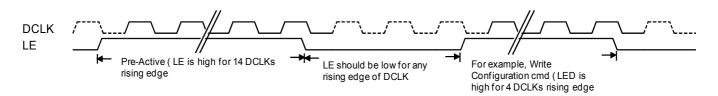
**Note:** When the power is on, Vsync command will be valid only after 16 times of "Data Latch" commands that have been sent in advance.

The following figures show the waveforms of commands which require or don't require "Pre-Active" ahead.

#### Commands which don't require Pre-Active ahead



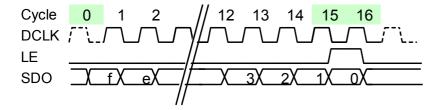
#### **Commands which require Pre-Active ahead**



#### **Waveform of Commands**

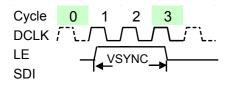
The following figures show the waveforms of each command.

#### **Data Latch**



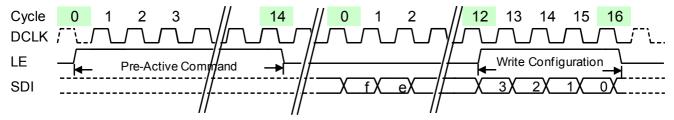
Data Latch command is used to latch the 16-bit shift register from SDI to internal SRAM buffer. When this command is received, the last 16 bits data before the falling edge of LE will be latched into SRAM, as shown in the above waveform, and MSB bit needs to be sent first.

#### **Vertical Sync (VSYNC)**



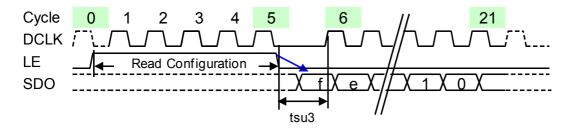
"VSYNC" command is used to update frame data on output channels ( $\overline{OUT0}\sim OUT15$ ). There are some timing limitations between signal "LE" and "GCLK"; and please refer to the section of "Vsync Command Operation" for details.

#### **Write Configuration**



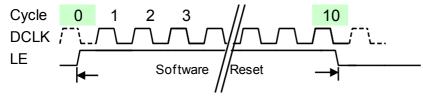
"Write configuration" command is used to program the configuration register of MBI5155. The "Pre-Active" command must be sent in advance. When this command is received, the last 16 bits data before the falling edge of LE will be latched into configuration register, as shown in the above waveform, and MSB bit needs to be sent first.

#### **Read Configuration**



"Read configuration" command is used to read the configuration register of MBI5155. When this command is received, the 16-bit data of configuration register will be shifted out from SDO pin, as shown in the above waveform, and MSB bit will be shifted out first.

#### **Software Reset**



"Software reset" command makes MBI5155 go back to the initial state except configuration register value. After this command is received, the output channels will be turned off and will display again with last gray-scale value after new "Vsync" command is received.

## 1:32 Time-multiplexing Applications

## **Definition of Configuration Register 1**

| MSB |   |   |   |   |   |   |   |   |   |   |   |   |   |   | LSB |
|-----|---|---|---|---|---|---|---|---|---|---|---|---|---|---|-----|
| F   | Е | D | C | В | Α | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0   |

e.g. Default Value

| F | Е | D | С | В | Α | 9 | 8 | 7 | 6 | 5 | 4 | 3     | 2    | 1 | 0 |
|---|---|---|---|---|---|---|---|---|---|---|---|-------|------|---|---|
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 |   | ı | 6'b10 | 1011 |   |   |

Default setting of configuration register is 16'h032B

| Bit | Attribute                    | Definition              | Value   | Function  |
|-----|------------------------------|-------------------------|---|---|
| _   | Dood Marita                  | Lower ghost             | 0 (Default)                                     | 0:Disable   |
| F   | Read/Write                   | elimination             | o (Delault)                                     | 1:Enabled   |
| E~D | Reserved                     | Reserved                | 00 (Default)                                    | Reserved  |
| C-8 | Read/Write                   | Number of scan lines    | 00000<br>00001<br>00010<br>00011 (Default)<br>~ | 00000: 1 line<br>00001: 2 lines<br>00010: 3 lines<br>00011: 4 lines<br><br>11110: 31 lines<br>11111: 32 lines   |
| 7   | Read/Write                   | Gray scale mode         | 0 (Default)                                     | The 65536 GCLKs (16-bit) PWM cycle is divided into 64 sections, and each section has 1024 GCLKs.  The 16384 GCLKs(14-bit) PWM cycle is divided into 32 sections, and each section |
|     |                              |                         | 0 (Default)                                     | has 512 GCLKs.,  0:GCLK multiplier disable  |
| 6   | 6 Read/Write GCLK multiplier | GCLK multiplier         | 1   | 1:GCLK multiplier enable  |
| 5~0 | Read/Write                   | Current gain adjustment | 000000~111111                                   | 6'b101011 (Default) Allow 64-step programmable current gain from 12.5 % to 200%   |

## **Definition of Configuration Register 2**

| MSB |   |   |   |   |   |   |   |          |   |   |   |   |   |   | LSB |
|-----|---|---|---|---|---|---|---|----------|---|---|---|---|---|---|-----|
| F   | Е | D | С | В | Α | 9 | 8 | 7        | 6 | 5 | 4 | 3 | 2 | 1 | 0   |
|     |   |   |   |   |   |   |   | <u> </u> |   |   |   |   | _ |   |     |

#### e.g. Default Value

| _ |   |   |   |   |   |   |   |   |   |   |   |   |   |   |   |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| F | Е | D | С | В | Α | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |

Default setting of configuration register is 16'h032B

| Bit | Attribute  | Definition            | Value           | Function   |
|-----|------------|-----------------------|-----------------|--|
| F∼B | Reserved   | Reserved              | Reserved        | Reserved   |
| Α   | Read/Write | Double                | 0(Default)      | 0: Disable   |
| A   | Reau/wille | refresh rate          | o(Delault)      | 1: Enable  |
| 9~4 | Reserved   | Reserved              | 000001(Default) | Reserved   |
| 3~1 | Read/Write | dim line compensation | 000 (Default)   | 000: 0 ns, 100: 20ns<br>001: 5 ns, 101: 25ns<br>010: 10 ns, 110: 30ns<br>011: 15 ns, 111: 35ns |
| 0   | Reserved   | Reserved              | Reserved        | Reserved   |

#### **Number of Scan Line**

MBI5155 supports 1 to 32 scan lines. Please set the configuration register1 bit [B:8] according to the application. The default value '0011' is 4 scan lines.

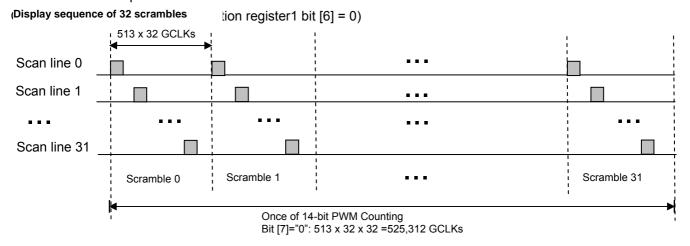
#### **Gray Scale Mode and Scan-type S-PWM**

MBI5155 provides a selectable 16-bit or 14-bit gray scale by setting the configuration register1 bit [7]. The default value is set to '0' for 16-bit color depth. In 14-bit gray scale mode, users should still send 16-bit data with 2-bit '0' in LSB bits. For example, {14'h1234, 2'h0}.

MBI5155 has a smart S-PWM technology for scan type. With S-PWM, the total PWM cycles can be broken into MSB (Most Significant Bits) and LSB (Least Significant Bits) of gray scale cycles. The MSB information can be broken down into many refresh cycles to achieve overall same high bit resolution.

#### **GCLK** multiplier

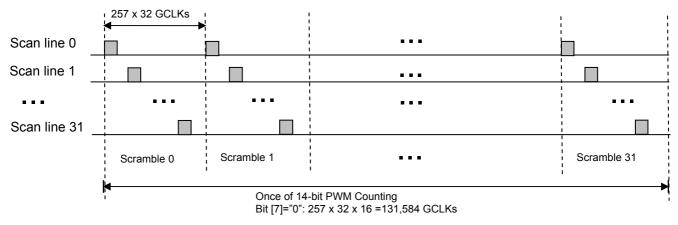
MBI5155 provides a GCLK multiplier function by setting the configuration register1 bit [6]. The default value is set to '0' for GCLK multiplier disable.



: Output ports are turned "on".

GCLK multiplier enabled (configuration register1 bit [6] = 1)

#### Display sequence of 32 scrambles

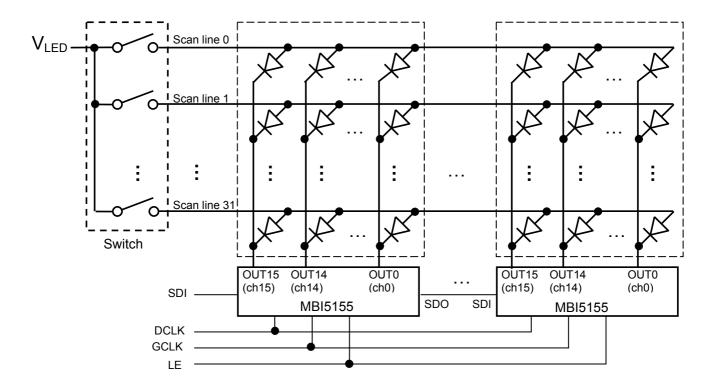


: Output ports are turned "on".

## 1:32 Time-multiplexing Applications

#### **Operation Principal**

#### Scan type application structure

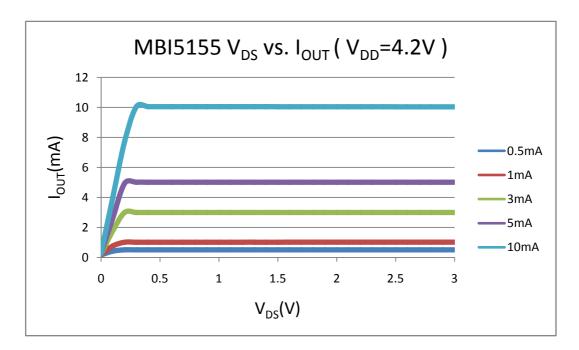


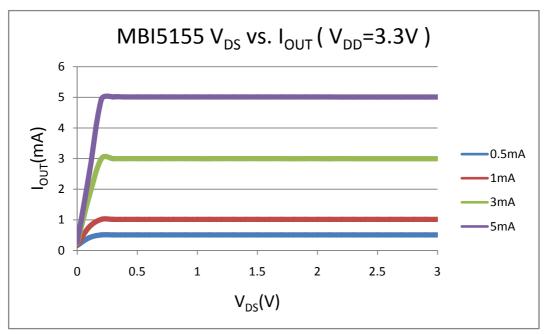
The above figure shows the suggested application structure of scan type scheme with 32 scan lines. The gray-scale data are sent by pin "SDI and SDO" with the commands formed by pin "LE" and "DCLK". The output ports from 16 channels ( $\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$ ) will output the PWM result for each scan line at different time, so there must be one "Switch" to multiplex for each scan line. The switching sequence and method and the command usage will be described in the application note.

#### **Constant Current**

In LED display application, MBI5155 provides nearly no variation in current from channel to channel and from IC to IC. This can be achieved by:

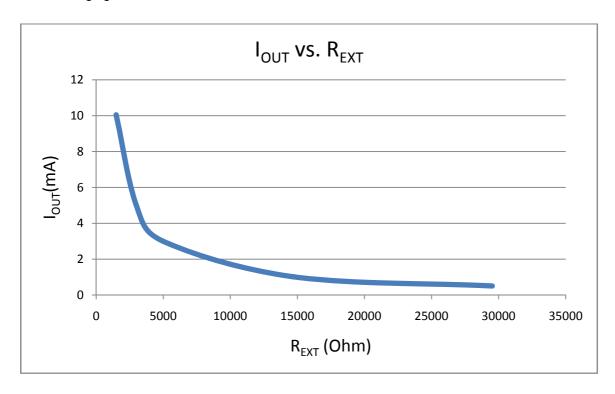
- 1) The maximuml current variation between channels is less than 2.5%, and that between ICs is less than ±3%
- 2) In addition, the current characteristic of output stage is flat and user can refer to the figure below. The output current can be kept constant regardless of the variations of LED forward voltages ( $V_F$ ). This guarantees LED to be performed on the same brightness as user's specification.





#### **Setting Output Current**

The output current ( $I_{OUT}$ ) is set by an external resistor,  $R_{ext}$ . The default relationship between  $I_{OUT}$  and  $R_{ext}$  is shown in the following figure.



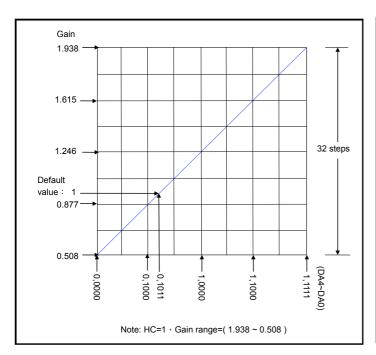
Also, the output current can be calculated from the equation:

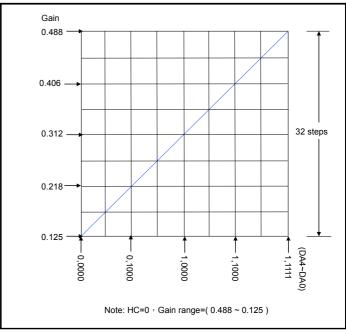
 $V_{R-EXT}$ =0.6Volt x G;  $I_{OUT}$ = ( $V_{R-EXT}/R_{ext}$ ) x G x 24

Whereas  $R_{\text{ext}}$  is the resistance of the external resistor connected to R-EXT terminal and  $V_{\text{R-EXT}}$  is its voltage. G is the digital current gain, which is set by the bit5 – bit0 of the configuration register. The default value of G is 1. The formula and setting for G are described in next section.

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#### **Current Gain Adjustment**





The 6 bits (bit 5~bit 0) of the configuration register set the gain of output current, i.e., G. As total 6-bit in number, i.e., ranging from 6'b000000 to 6'b111111, these bits allow user to set the output current gain up to 64 levels. These bits can be further defined inside configuration register as follows:

| F | Е | D | С | В | Α | 9 | 8 | 7 | 6 | 5  | 4   | 3   | 2   | 1   | 0   |
|---|---|---|---|---|---|---|---|---|---|----|-----|-----|-----|-----|-----|
| - | 1 | - | 1 | 1 | 1 | 1 | ı | 1 | ı | НС | DA4 | DA3 | DA2 | DA1 | DA0 |

- 1. Bit 5 is HC bit. The setting is in low current band when HC=0, and in high current band when HC=1.
- 2. Bit 4 to bit 0 are DA4 ~ DA0.

The relationship between these bits and current gain G is:

HC=1, D=(65xG-33)/3

HC=0, D=(256xG-32)/3

and D in the above decimal numeration can be converted to its equivalent in binary form by the following equation:

D= DA4x2<sup>4</sup>+DA3x2<sup>3</sup>+DA2x2<sup>2</sup>+DA1x2<sup>1</sup>+DA0x2<sup>0</sup>

In other words, these bits can be looked as a floating number with 1-bit exponent HC and 5-bit mantissa DA4~DA0. For example,

HC=1, G=1.246, D=(65x1.246-33)/3=16

the D in binary form would be:

 $D=16=1x2^4+0x2^3+0x2^2+0x2^1+0x2^0$ 

The 6 bits (bit 5~bit 0) of the configuration register are set to 6'b110000.

#### **Package Power Dissipation (PD)**

The maximum allowable package power dissipation is determined as  $P_D(max)=(Tj-Ta)/R_{th(j-a)}$ . When 16 output channels are turned on simultaneously, the actual package power dissipation is

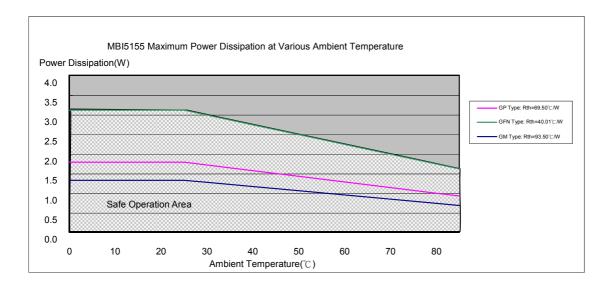
 $P_D(act)=(I_{DD}xV_{DD})+(I_{OUT}xDutyxV_{DS}x16)$ . Therefore, to keep  $P_D(act)\leq P_D(max)$ , the allowable maximum output current as a function of duty cycle is:

 $I_{OUT} = \{ [(Tj - Ta)/R_{th(j-a)}] - (I_{DD}xV_{DD})\}/V_{DS}/Duty/16, \ where \ Tj = 150 ^{\circ}C.$ 

Please see the follow table for  $P_D$  and  $R_{th(j-a)}$  for different packages:

| Device Type | $R_{th(j-a)}$ (°C/W) | $P_D(W)$ |  |
|-------------|----------------------|----------|--|
| GP          | 69.50                | 1.79     |  |
| GM          | 93.5                 | 1.07     |  |
| GFN         | 40.01                | 3.12     |  |

The maximum power dissipation,  $P_D(max)=(Tj-Ta)/R_{th(j-a)}$ , decreases as the ambient temperature increases.

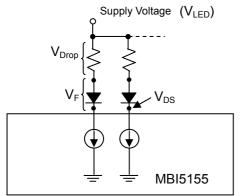


#### **LED Supply Voltage (V<sub>LED</sub>)**

MBI5155 is designed to operate with  $V_{DS}$  ranging from 0.4V to 1.0V (depending on  $I_{OUT}$ =0.5~20mA) considering the package power dissipating limits.  $V_{DS}$  may be higher enough to make  $P_{D (act)} > P_{D (max)}$  when  $V_{LED}$ =5V and  $V_{DS}$ = $V_{LED}$ - $V_F$ , in which  $V_{LED}$  is the load supply voltage. In this case, it is recommended to use the lowest possible supply voltage or to set an external voltage reducer,  $V_{DROP}$ .

A voltage reducer lets  $V_{DS}=(V_{LED}-V_F)-V_{DROP}$ .

Resistors or Zener diode can be used in the applications as shown in the following figures.



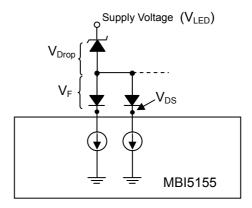


Figure 5

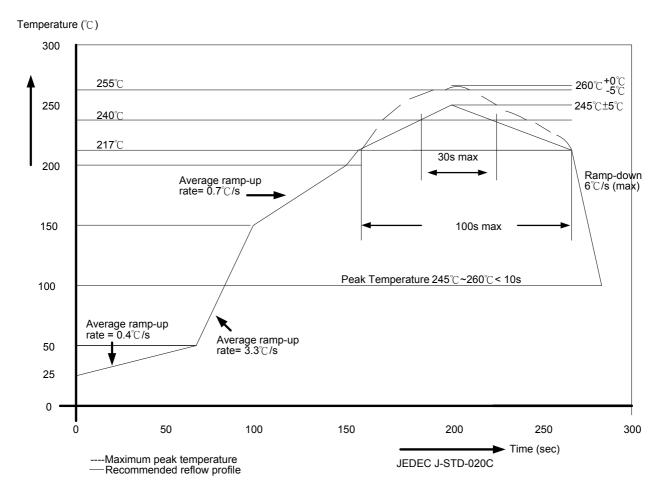
#### **Switching Noise Reduction**

LED drivers are frequently used in switch-mode applications which always behave with switching noise due to the parasitic inductance on PCB. To eliminate switching noise, refer to "Application Note for 8-bit and 16-bit LED Drivers- Overshoot".

#### Soldering Process of "Pb-free & Green" Package Plating\*

Macroblock has defined "Pb-Free & Green" to mean semiconductor products that are compatible with the current RoHS requirements and selected 100% pure tin (Sn) to provide forward and backward compatibility with both the current industry-standard SnPb-based soldering processes and higher-temperature Pb-free processes. Pure tin is widely accepted by customers and suppliers of electronic devices in Europe, Asia and the US as the lead-free surface finish of choice to replace tin-lead. Also, it adopts tin/lead (SnPb) solder paste, and please refer to the JEDEC J-STD-020C for the temperature of solder bath. However, in the whole Pb-free soldering processes and materials, 100% pure tin (Sn) will all require from 245 °C to 260°C for proper soldering on boards, referring to JEDEC J-STD-020C as shown below.

For managing MSL3 Package, it should refer to JEDEC J-STD-020C about floor life management & refer to JEDEC J-STD-033C about re-bake condition while IC's floor life exceeds MSL3 limitation.

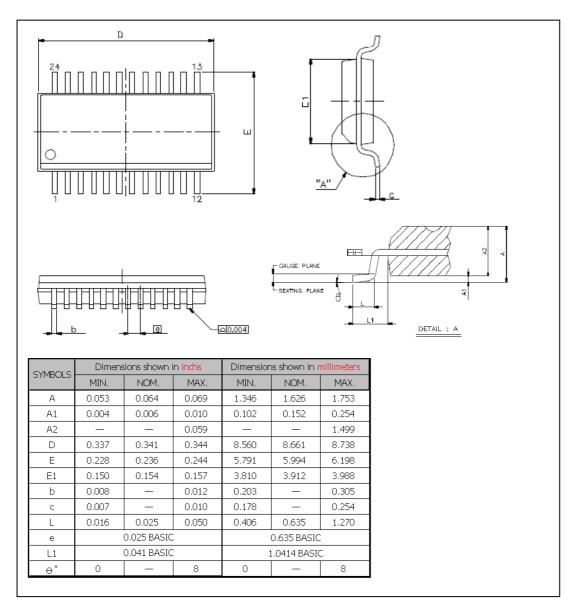


| Package Thickness | Volume mm <sup>3</sup><br><350 | Volume mm <sup>3</sup><br>350-2000 | Volume mm³<br>≧2000 |
|-------------------|--------------------------------|------------------------------------|---------------------|
| <1.6mm            | 260 +0 °C                      | 260 +0 °C                          | 260 +0 °C           |
| 1.6mm – 2.5mm     | 260 +0 °C                      | 250 +0 °C                          | 245 +0 °C           |
| ≧2.5mm            | 250 +0 °C                      | 245 +0 °C                          | 245 +0 °C           |

<sup>\*</sup>Note: For details, please refer to Macroblock's "Policy on Pb-free & Green Package".

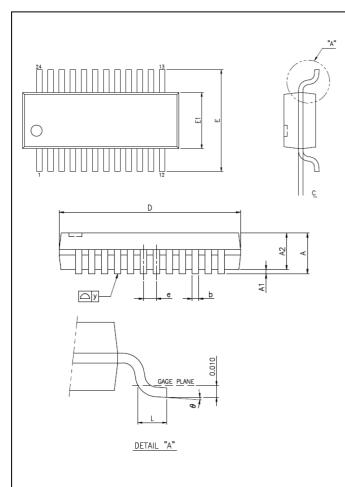
1:32 Time-multiplexing Applications

### **Package Outline**



MBI5155 GP Outline Drawing

# 16-Channel Low Knee Voltage PWM Constant Current LED Driver for Low Voltage Power Supply, 1:32 Time-multiplexing Applications

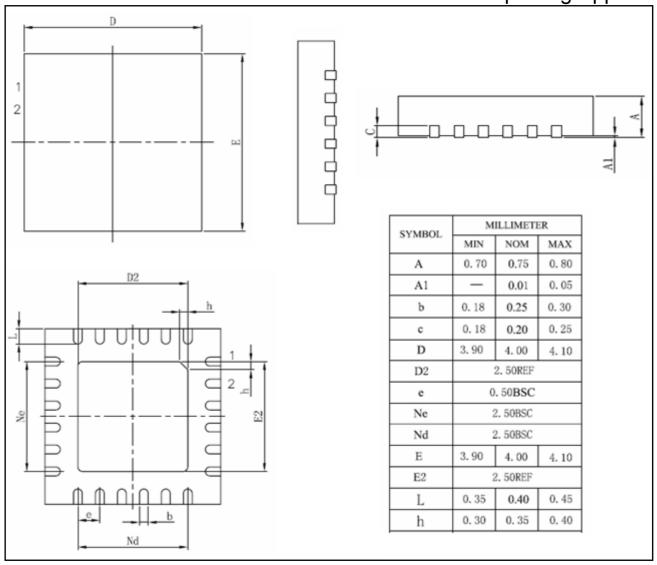


| SYMBOLS   | DIMENSIO | NS SHOW | N IN INCH | DIMENSIONS SHOWN IN MM |       |       |  |
|-----------|----------|---------|-----------|------------------------|-------|-------|--|
| STIVIDOLO | MIN.     | NOM.    | MAX.      | MIN.                   | NOM.  | MAX.  |  |
| Α         | 0.058    | 0.063   | 0.068     | 1.473                  | 1.600 | 1.727 |  |
| A1        | 0.004    | 0.006   | 0.010     | 0.102                  | 0.152 | 0.254 |  |
| A2        | 0.054    | 0.057   | 0.060     | 1.372                  | 1.448 | 1.524 |  |
| b         | 0.008    | 0.010   | 0.012     | 0.203                  | 0.254 | 0.305 |  |
| С         | 0.007    | 0.008   | 0.010     | 0.178                  | 0.203 | 0.254 |  |
| D         | 0.276    | 0.280   | 0.284     | 7.010                  | 7.112 | 7.214 |  |
| E         | 0.178    | 0.182   | 0.185     | 4.521                  | 4.623 | 4.699 |  |
| E1        | 0.096    | 0.100   | 0.103     | 2.438                  | 2.540 | 2.616 |  |
| е         | _        | 0.020   | _         | _                      | 0.508 | _     |  |
| L         | 0.016    | 0.025   | 0.050     | 0.406                  | 0.635 | 1.270 |  |
| у         | _        | _       | 0.003     | _                      | _     | 0.076 |  |
| Θ         | 0°       | _       | 8°        | 0°                     | _     | 8°    |  |

#### NOTES:

- 1. JEDEC OUTLINE: N/A
- 2. DIMENSION D DOES NOT INCLUDE MOLD PROTRUSIONS OR GATE BURRS. MOLD PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.006" PER SIDE. DIMENSION E1 DOES NOT INCLUDE INTERLEAD MOLD PROTRUSIONS. INTERLEAD MOLD PROTRUSIONS SHALL NOT EXCEED 0.010" PER SIDE.
- 3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION/ INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.004" TOTAL IN EXCESS OF b DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION b BY MORE THAN 0.002" AT LEAST.

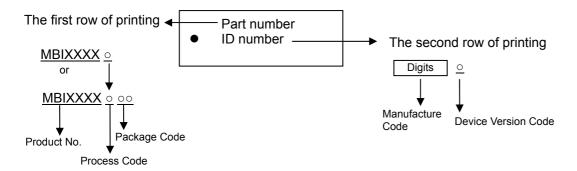
MBI5155 GM Outline Drawing



MBI5155GFN Outline Drawing

## 1:32 Time-multiplexing Applications

### **Product Top Mark Information**



#### **Product Revision History**

| Datasheet Version | Devise Version Code |
|-------------------|---------------------|
| V1.00             | Α                   |

#### **Product Ordering Information**

| Product Ordering Number* | RoHS Compliant Package Type | Weight (g) |
|--------------------------|-----------------------------|------------|
| MBI5155GP-A              | SSOP24L-150-0.64            | 0.11       |
| MBI5155GM-A              | mSSOP24L-100-0.5            | 0.079      |
| MBI5155GFN-A             | QFN24L-4*4-0.5              | 0.0379     |

<sup>\*</sup>Please place your order with the "product ordering number" information on your purchase order (PO).

# 16-Channel Low Knee Voltage PWM Constant Current LED Driver for Low Voltage Power Supply, 1:32 Time-multiplexing Applications

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